

## N-Channel Enhancement Mode Power MOSFET

### Description

The HM40N10KA uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

### General Features

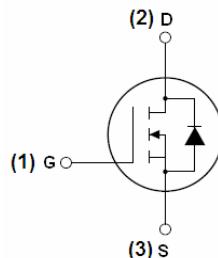
- $V_{DS} = 100V, I_D = 40A$
- $R_{DS(ON)} < 17m\Omega @ V_{GS}=10V$  (Typ:14m $\Omega$ )
- Special process technology for high ESD capability
- High density cell design for ultra low  $R_{DS(on)}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high  $E_{AS}$
- Excellent package for good heat dissipation

### Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

**100% UIS TESTED!**

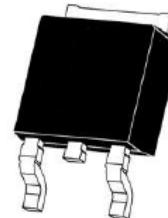
**100%  $\Delta V_{ds}$  TESTED!**



Schematic diagram



Marking and pin assignment



TO-252-2L top view

### Package Marking and Ordering Information

| Device Marking | Device    | Device Package | Reel Size | Tape width | Quantity |
|----------------|-----------|----------------|-----------|------------|----------|
| HM40N10KA      | HM40N10KA | TO-252-2L      | -         | -          | -        |

### Absolute Maximum Ratings ( $T_C=25^\circ C$ unless otherwise noted)

| Parameter                                        | Symbol              | Limit      | Unit          |
|--------------------------------------------------|---------------------|------------|---------------|
| Drain-Source Voltage                             | $V_{DS}$            | 100        | V             |
| Gate-Source Voltage                              | $V_{GS}$            | $\pm 20$   | V             |
| Drain Current-Continuous                         | $I_D$               | 40         | A             |
| Drain Current-Continuous( $T_C=100^\circ C$ )    | $I_D (100^\circ C)$ | 28         | A             |
| Pulsed Drain Current                             | $I_{DM}$            | 160        | A             |
| Maximum Power Dissipation                        | $P_D$               | 140        | W             |
| Derating factor                                  | -                   | 0.94       | W/ $^\circ C$ |
| Single pulse avalanche energy (Note 5)           | $E_{AS}$            | 520        | mJ            |
| Operating Junction and Storage Temperature Range | $T_J, T_{STG}$      | -55 To 175 | $^\circ C$    |

### Thermal Characteristic

|                                                         |                  |      |      |
|---------------------------------------------------------|------------------|------|------|
| Thermal Resistance,Junction-to-Case <sup>(Note 2)</sup> | R <sub>θJC</sub> | 1.07 | °C/W |
|---------------------------------------------------------|------------------|------|------|

### Electrical Characteristics (T<sub>c</sub>=25°C unless otherwise noted)

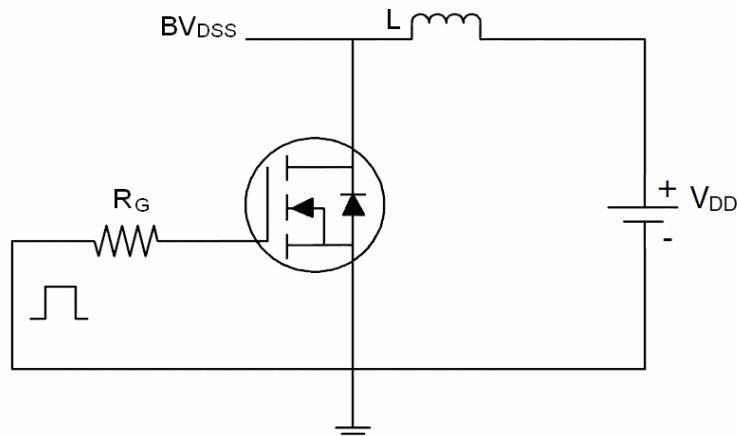
| Parameter                                            | Symbol              | Condition                                                              | Min | Typ  | Max  | Unit |
|------------------------------------------------------|---------------------|------------------------------------------------------------------------|-----|------|------|------|
| <b>Off Characteristics</b>                           |                     |                                                                        |     |      |      |      |
| Drain-Source Breakdown Voltage                       | V <sub>DSS</sub>    | V <sub>GS</sub> =0V I <sub>D</sub> =250μA                              | 100 | 110  | -    | V    |
| Zero Gate Voltage Drain Current                      | I <sub>DSS</sub>    | V <sub>DS</sub> =100V, V <sub>GS</sub> =0V                             | -   | -    | 1    | μA   |
| Gate-Body Leakage Current                            | I <sub>GSS</sub>    | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V                             | -   | -    | ±100 | nA   |
| <b>On Characteristics</b> <sup>(Note 3)</sup>        |                     |                                                                        |     |      |      |      |
| Gate Threshold Voltage                               | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA               | 0.9 | 1.1  | 1.5  | V    |
| Drain-Source On-State Resistance                     | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =28A                              | -   | 14   | 17   | mΩ   |
| Forward Transconductance                             | g <sub>FS</sub>     | V <sub>DS</sub> =25V, I <sub>D</sub> =28A                              | 32  | -    | -    | S    |
| <b>Dynamic Characteristics</b> <sup>(Note 4)</sup>   |                     |                                                                        |     |      |      |      |
| Input Capacitance                                    | C <sub>iss</sub>    | V <sub>DS</sub> =30V, V <sub>GS</sub> =0V,<br>F=1.0MHz                 | -   | 3400 | -    | PF   |
| Output Capacitance                                   | C <sub>oss</sub>    |                                                                        | -   | 290  | -    | PF   |
| Reverse Transfer Capacitance                         | C <sub>rss</sub>    |                                                                        | -   | 221  | -    | PF   |
| <b>Switching Characteristics</b> <sup>(Note 4)</sup> |                     |                                                                        |     |      |      |      |
| Turn-on Delay Time                                   | t <sub>d(on)</sub>  | VDD=30V, ID=2A, RL=15Ω,<br>RG=2.5Ω, VGS=10V                            | -   | 15   | -    | nS   |
| Turn-on Rise Time                                    | t <sub>r</sub>      |                                                                        | -   | 11   | -    | nS   |
| Turn-Off Delay Time                                  | t <sub>d(off)</sub> |                                                                        | -   | 52   | -    | nS   |
| Turn-Off Fall Time                                   | t <sub>f</sub>      |                                                                        | -   | 13   | -    | nS   |
| Total Gate Charge                                    | Q <sub>g</sub>      | ID=30A, VDD=30V, VGS=10V                                               | -   | 94   | -    | nC   |
| Gate-Source Charge                                   | Q <sub>gs</sub>     |                                                                        | -   | 16   | -    | nC   |
| Gate-Drain Charge                                    | Q <sub>gd</sub>     |                                                                        | -   | 24   | -    | nC   |
| <b>Drain-Source Diode Characteristics</b>            |                     |                                                                        |     |      |      |      |
| Diode Forward Voltage <sup>(Note 3)</sup>            | V <sub>SD</sub>     | V <sub>GS</sub> =0V, I <sub>S</sub> =28A                               | -   | 0.85 | 1.2  | V    |
| Diode Forward Current <sup>(Note 2)</sup>            | I <sub>S</sub>      |                                                                        | -   | -    | 40   | A    |
| Reverse Recovery Time                                | t <sub>rr</sub>     | T <sub>J</sub> = 25°C, IF = 28A<br>di/dt = 100A/μs <sup>(Note 3)</sup> | -   | 33   |      | nS   |
| Reverse Recovery Charge                              | Q <sub>rr</sub>     |                                                                        | -   | 54   |      | nC   |
| Forward Turn-On Time                                 | t <sub>on</sub>     | Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)   |     |      |      |      |

### Notes:

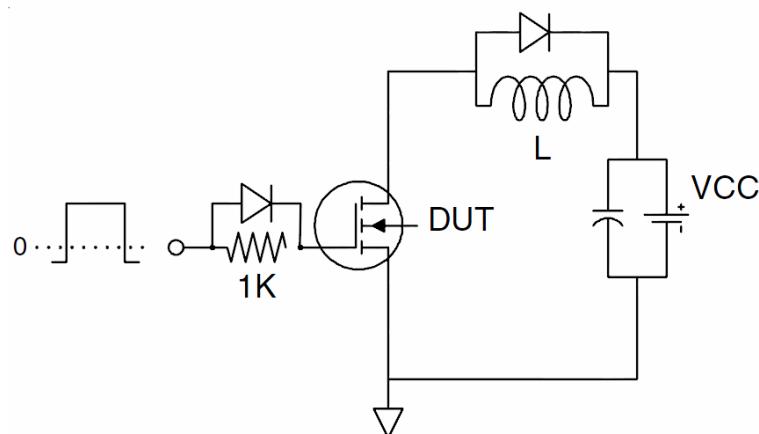
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production
5. EAS condition: T<sub>j</sub>=25°C, V<sub>DD</sub>=50V, V<sub>G</sub>=10V, L=0.5mH, R<sub>g</sub>=25Ω

### Test Circuit

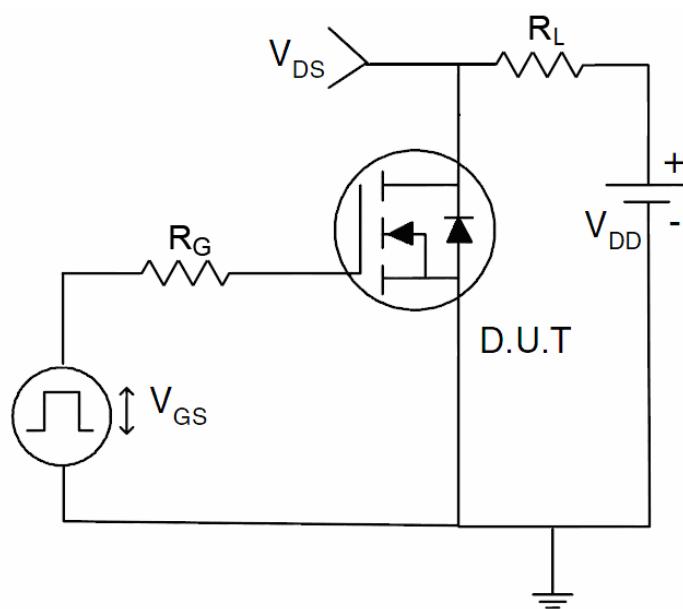
#### 1) E<sub>AS</sub> test Circuit



#### 2) Gate charge test Circuit



#### 3) Switch Time Test Circuit



### Typical Electrical and Thermal Characteristics (Curves)

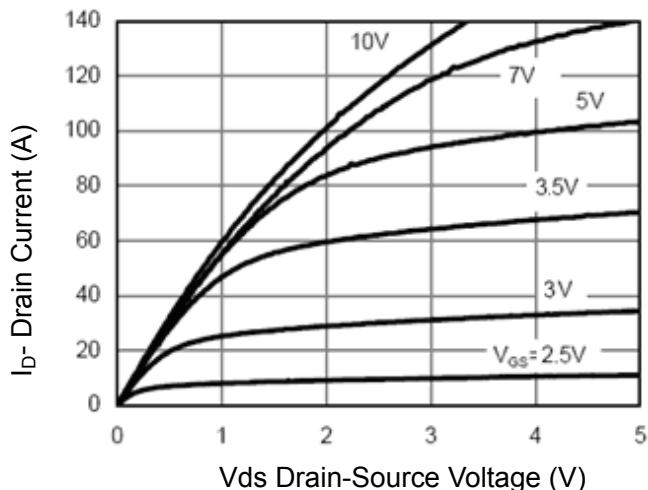


Figure 1 Output Characteristics

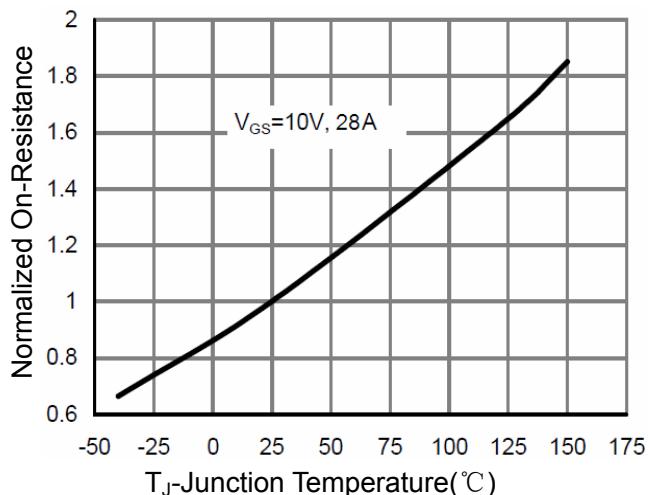


Figure 4 Rdson-JunctionTemperature

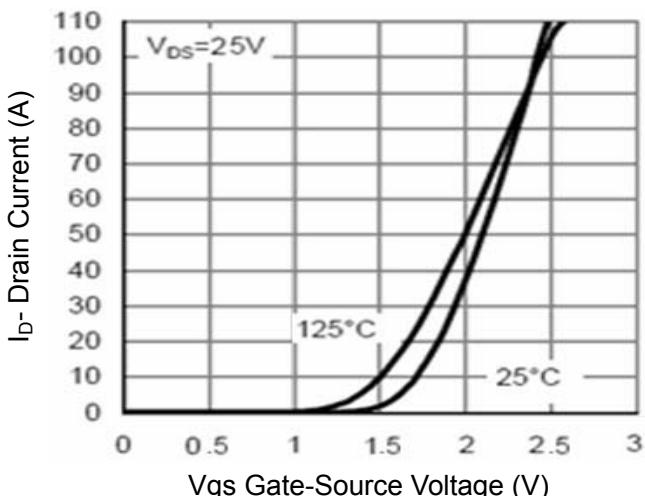


Figure 2 Transfer Characteristics

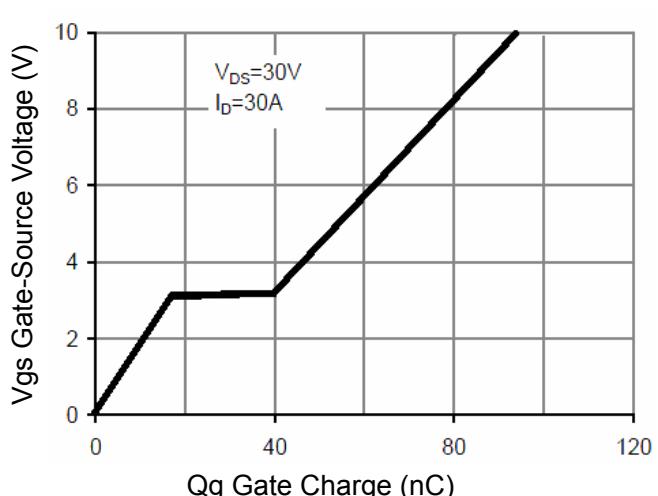


Figure 5 Gate Charge

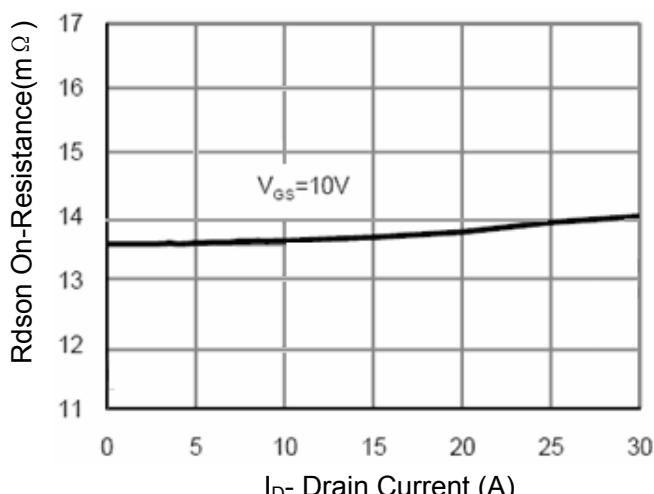


Figure 3 Rdson- Drain Current

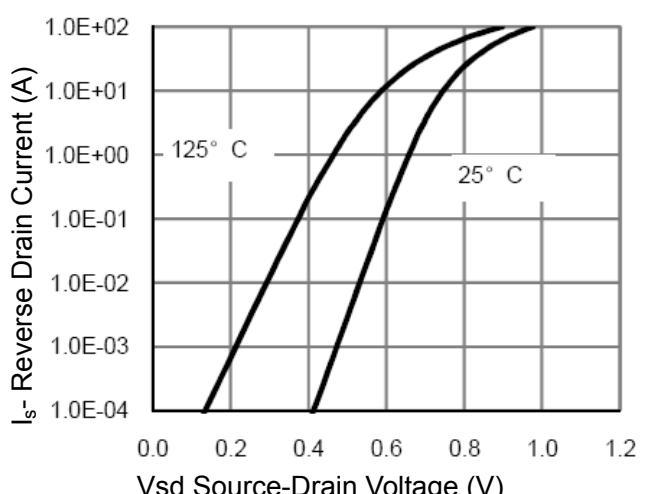


Figure 6 Source- Drain Diode Forward

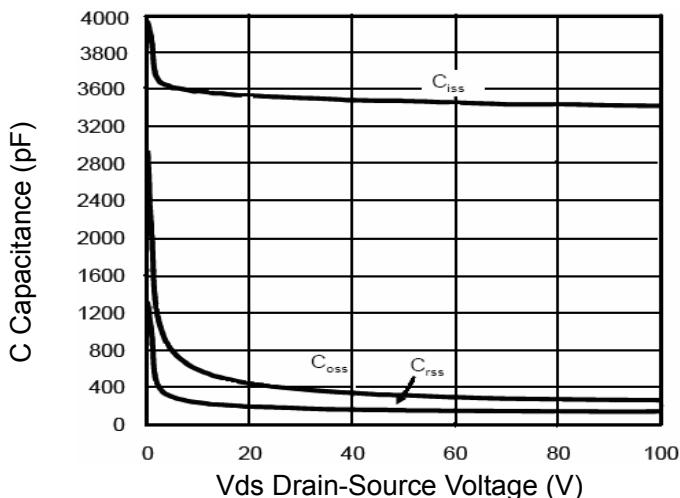


Figure 7 Capacitance vs Vds

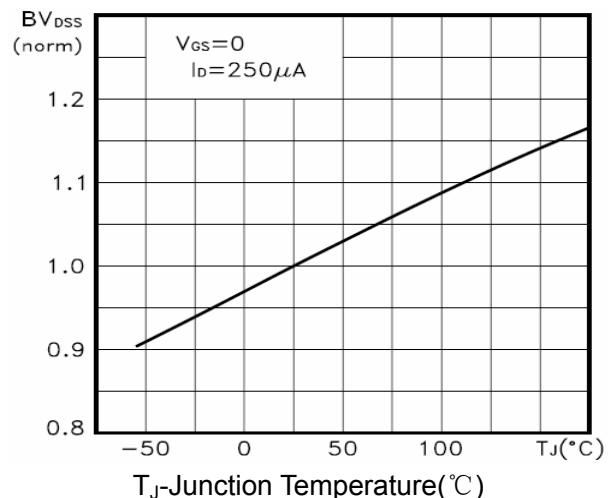


Figure 9 BV<sub>DSS</sub> vs Junction Temperature

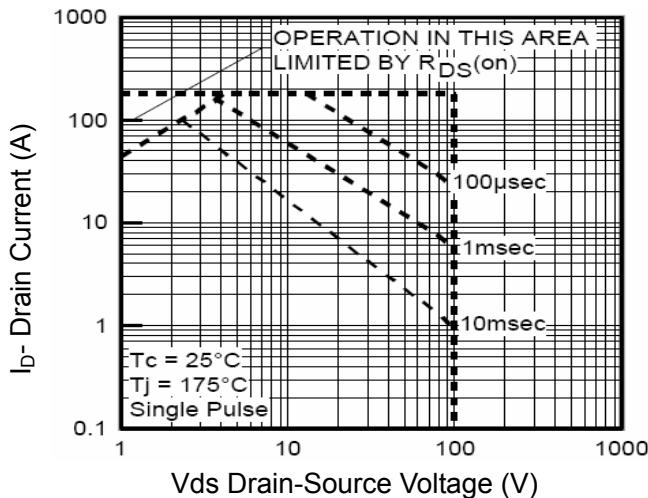


Figure 8 Safe Operation Area

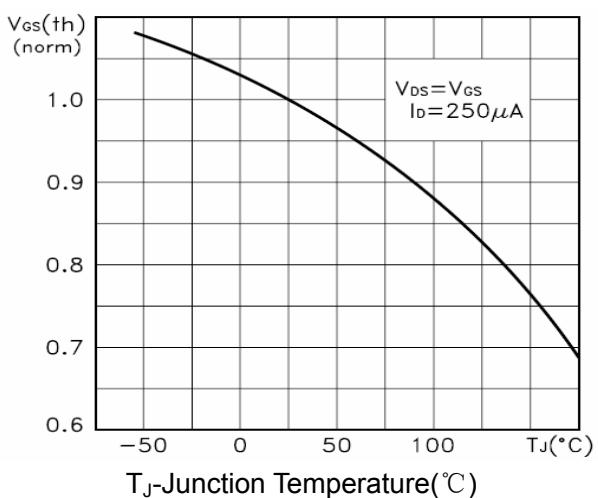


Figure 10 V<sub>GS(th)</sub> vs Junction Temperature

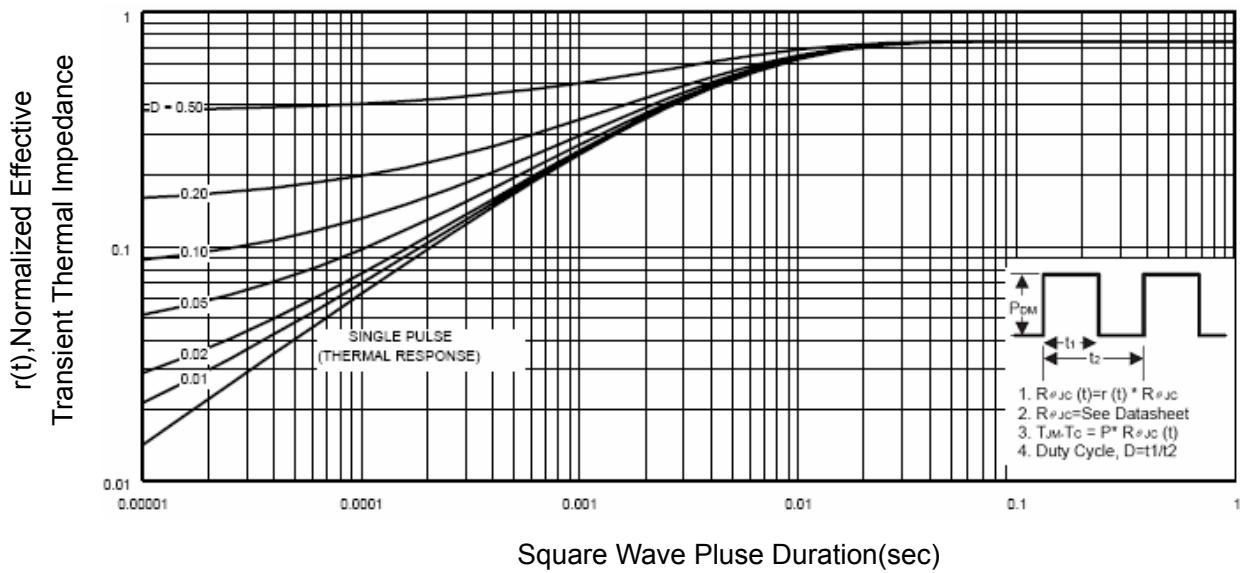
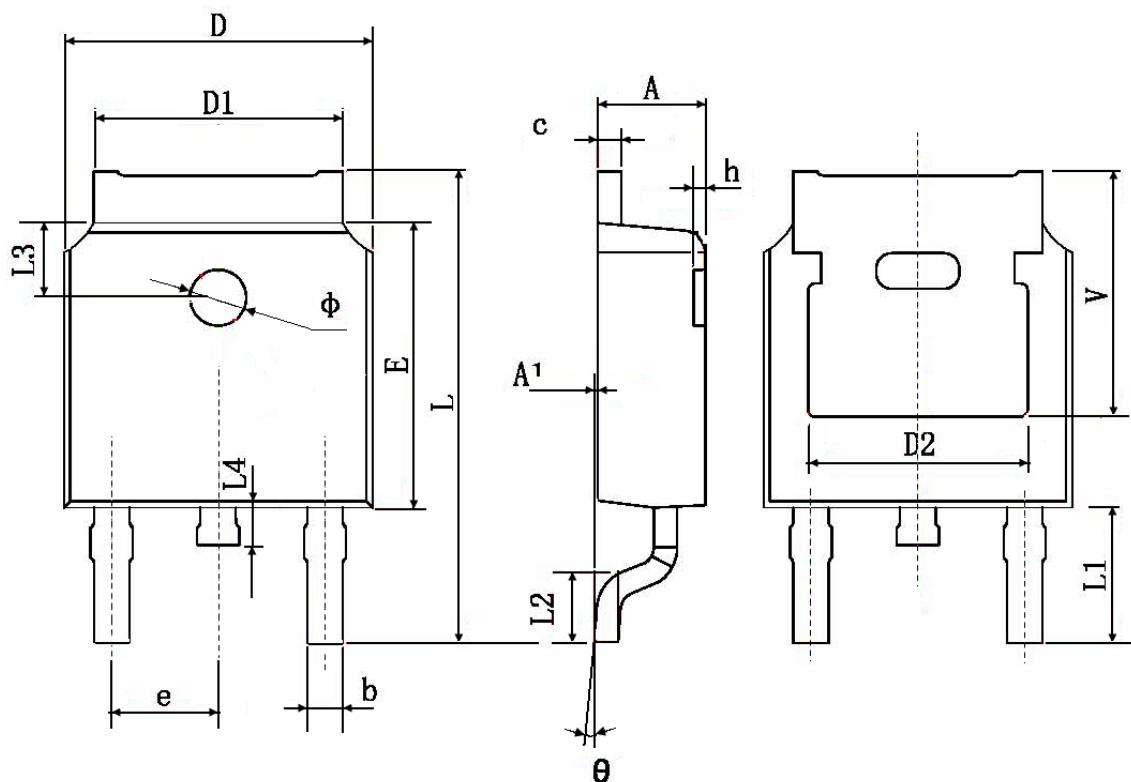


Figure 11 Normalized Maximum Transient Thermal Impedance

TO-252 Package Information



| Symbol | Dimensions In Millimeters |        | Dimensions In Inches |       |
|--------|---------------------------|--------|----------------------|-------|
|        | Min.                      | Max.   | Min.                 | Max.  |
| A      | 2.200                     | 2.400  | 0.087                | 0.094 |
| A1     | 0.000                     | 0.127  | 0.000                | 0.005 |
| b      | 0.660                     | 0.860  | 0.026                | 0.034 |
| c      | 0.460                     | 0.580  | 0.018                | 0.023 |
| D      | 6.500                     | 6.700  | 0.256                | 0.264 |
| D1     | 5.100                     | 5.460  | 0.201                | 0.215 |
| D2     | 4.830 TYP.                |        | 0.190 TYP.           |       |
| E      | 6.000                     | 6.200  | 0.236                | 0.244 |
| e      | 2.186                     | 2.386  | 0.086                | 0.094 |
| L      | 9.800                     | 10.400 | 0.386                | 0.409 |
| L1     | 2.900 TYP.                |        | 0.114 TYP.           |       |
| L2     | 1.400                     | 1.700  | 0.055                | 0.067 |
| L3     | 1.600 TYP.                |        | 0.063 TYP.           |       |
| L4     | 0.600                     | 1.000  | 0.024                | 0.039 |
| Φ      | 1.100                     | 1.300  | 0.043                | 0.051 |
| θ      | 0°                        | 8°     | 0°                   | 8°    |
| h      | 0.000                     | 0.300  | 0.000                | 0.012 |
| V      | 5.350 TYP.                |        | 0.211 TYP.           |       |